S5AC-K - S5MC-K

Taiwan Semiconductor

5A, 50V - 1000V Surface Mount Rectifier

FEATURES

- Glass passivated chip junction
- Ideal for automated placement
- Low forward voltage drop
- High current capability
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- Converter

MECHANICAL DATA

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Polarity: As marked
- Weight: 0.25 g (approximately)

	SYMBOL	S5	S 5						
PARAMETER		AC-K	BC-K	DC-K	GC-K	JC-K	КС-К	МС-К	UNIT
Marking code on the device		S5A	S5B	S5D	S5G	S5J	S5K	S5M	
Repetitive peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Reverse voltage, total rms value	V _{R(RMS)}	35	70	140	280	420	560	700	V
Forward current	I _F				5				Α
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load per diode	I _{FSM}	sм 100			A				
Junction temperature	TJ	- 55 to +150				°C			
Storage temperature	T _{STG}	- 55 to +150			°C				

KEY PARAMETERS				
VALUE	UNIT			
5	А			
50 - 1000	V			
100	А			
150	°C			
DO-214AB (SMC)				
	5 50 - 1000 100 150			



DO-214AB (SMC)







THERMAL PERFORMANCE					
PARAMETER	SYMBOL	TYP.	UNIT		
Junction-to-lead thermal resistance per diode	R _{θJL}	11	°C/W		
Junction-to-ambient thermal resistance per diode	R _{eJA}	48	°C/W		
Junction-to-case thermal resistance per diode	R _{eJC}	12	°C/W		

Thermal Performance Note: Units mounted on PCB (16mm x 16mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP.	MAX.	UNIT
Forward voltage per diode ⁽¹⁾	$I_F = 2.5A, T_J = 25^{\circ}C$	V _F	0.90	-	V
	$I_F = 5.0A, T_J = 25^{\circ}C$		0.96	1.15	V
	$I_F = 2.5A, T_J = 125^{\circ}C$		0.78	-	V
	$I_F = 5.0A, T_J = 125^{\circ}C$		0.85	1.00	V
Poweres surrent @ reted $V_{\rm c}$ per diade $^{(2)}$	$T_J = 25^{\circ}C$	I	-	10	μA
Reverse current @ rated V_R per diode ⁽²⁾	T _J = 125°C	I _R	-	250	μA
Junction capacitance	1 MHz, V _R =4.0V	CJ	34	-	pF

Notes:

1. Pulse test with PW=0.3 ms

2. Pulse test with PW=30 ms

ORDERING CODE	PACKAGE	PACKING
S5AC-K R7G	SMC	850 / 7" Plastic reel
S5AC-K M6G	SMC	3,000 / 13" Plastic ree
S5BC-K R7G	SMC	850 / 7" Plastic reel
S5BC-K M6G	SMC	3,000 / 13" Plastic ree
S5DC-K R7G	SMC	850 / 7" Plastic reel
S5DC-K M6G	SMC	3,000 / 13" Plastic ree
S5GC-K R7G	SMC	850 / 7" Plastic reel
S5GC-K M6G	SMC	3,000 / 13" Plastic ree
S5JC-K R7G	SMC	850 / 7" Plastic reel
S5JC-K M6G	SMC	3,000 / 13" Plastic ree
S5KC-K R7G	SMC	850 / 7" Plastic reel
S5KC-K M6G	SMC	3,000 / 13" Plastic ree
S5MC-K R7G	SMC	850 / 7" Plastic reel
S5MC-K M6G	SMC	3,000 / 13" Plastic ree



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

6 1000 AVERAGE FORWARD CURRENT (A) 5 4 100 CAPACITANCE (pF) 3 2 10 Heat sink 1 16mm x 16mm Cu pad test board f=1.0MHz Vsig=50mVp-p 0 1 75 25 50 100 125 150 1 CASE TEMPERATURE (C)

Fig.1 Forward Current Derating Curve

Fig.3 Typical Reverse Characteristics

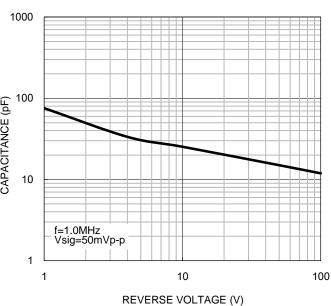
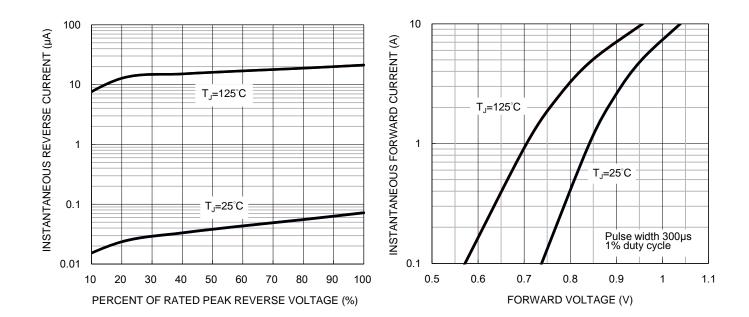


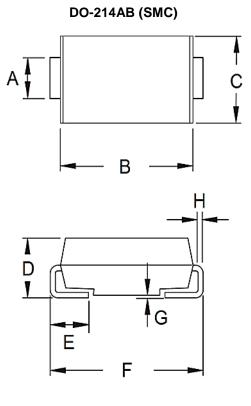
Fig.2 Typical Junction Capacitance

Fig.4 Typical Forward Characteristics



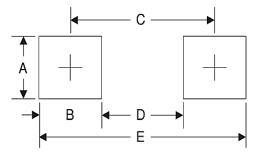


PACKAGE OUTLINE DIMENSIONS



DIM.	Unit	(mm)	Unit (inch)		
DIM.	Min	Min Max		Max	
А	2.90	3.20	0.114	0.126	
В	6.60	7.11	0.260	0.280	
С	5.59	6.22	0.220	0.245	
D	2.00	2.62	0.079	0.103	
Е	1.00	1.60	0.039	0.063	
F	7.75	8.13	0.305	0.320	
G	0.10	0.20	0.004	0.008	
Н	0.15	0.31	0.006	0.012	

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	3.30	0.130
В	2.50	0.098
С	6.80	0.268
D	4.40	0.173
E	9.40	0.370

MARKING DIAGRAM



P/N	= Marking Code			
G	=Green Compound			
YW	= Date Code			
F	= Factory Code			



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S5JC-K M6G
S5JC-K R7G
S5KC-K M6G

S5KC-K R7G
S5GC-K R7G
S5AC-K M6G
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